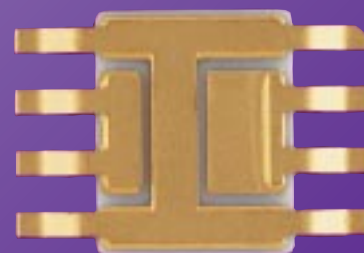
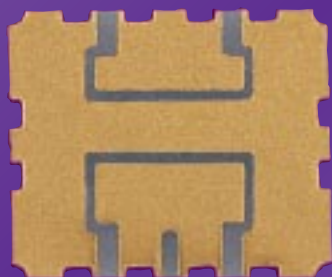
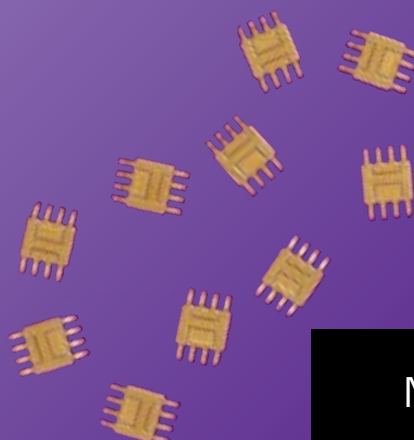


STANDARD SO-8 PACKAGES  
■ PRODUCT INFORMATION SHEET



A-787



F-0127



Enlarged view shown at approximately 7x actual size.

## MAJOR ADVANTAGES

### BERYLLIUM OXIDE VERSION:

- Excellent thermal properties
- Proven, robust metallization and brazing process
- Excellent solderability
- Price competitive

### ALUMINUM NITRIDE VERSION:

- Enhanced electrical properties from Thin Film metallization
- Cost effective
- Superior thermal properties
- No leads to deform
- Sized to fit standard outline
- 170 W/m · K thermal conductivity
- Surface mount design

*Custom designs are available for both Beryllium Oxide and Aluminum Nitride versions.*



